

Description

The Si4684 single-chip digital receiver is one member of a family of 100% CMOS digital radio broadcast receiver ICs from Silicon Labs. The Si468x family offers a complete and cost-effective digital radio solution integrating the RF tuner, baseband and audio processing on a single die. The high level of integration provides significant customer benefits compared to traditional digital radio solutions, including a reduction in system implementation complexity, validation and testing, and improved reliability and manufacturability.

The Si4684 offers VHF Band III (168-240 MHz) reception capability and is fully compliant with ETSI EN 300 401 and ETSI TS 102 563. The Si4688 supports DAB and DAB+ via an integrated source decoder that supports both MPEG Audio Layer 2 (DAB) and HE-AAC V2 (DAB+). The Si4684 supports data services such as Dynamic Labels, Intellitext, Electronic Program Guide (EPG), Slideshow and Journaline® with the appropriate external decoders.

The Si4684 additionally supports worldwide FM radio reception and incorporates a fully integrated decoder for the European Radio Data System (RDS) and the North American Radio Broadcast Data System (RDBS) including all required symbol decoding, block synchronization, error detection, and error correction functions.

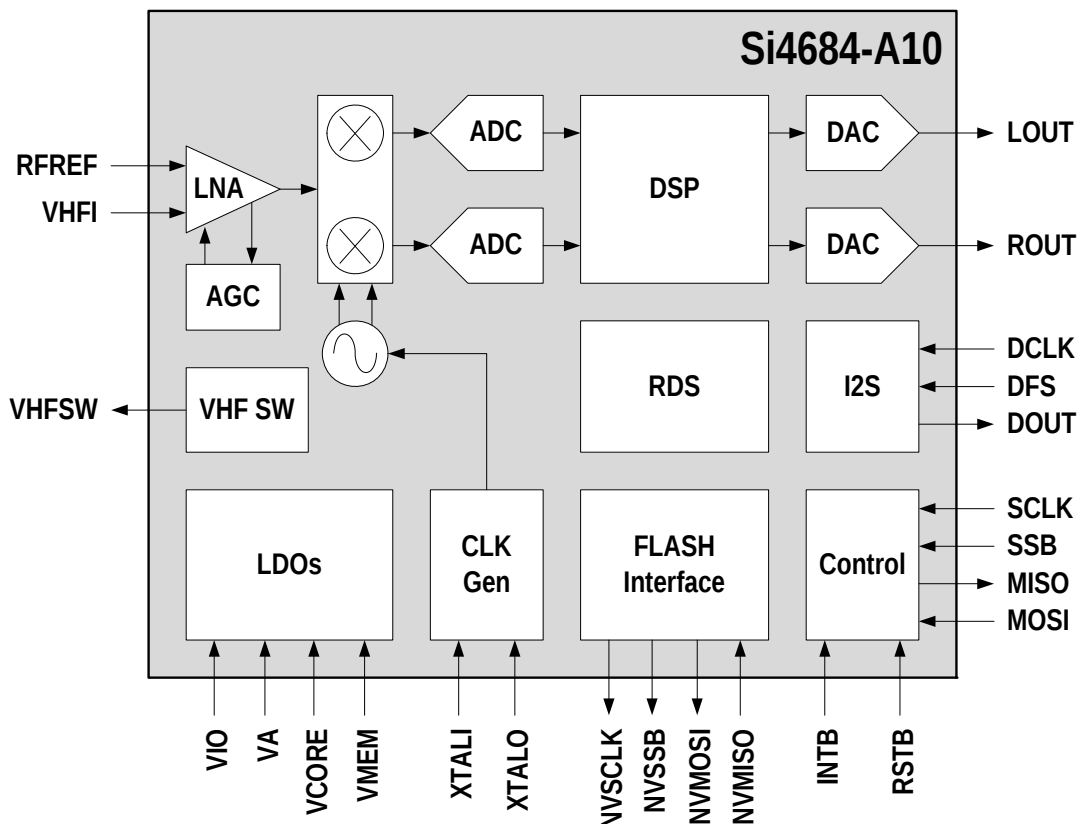
[For more information, visit the Si468x Digital Radio Receivers web page.](#)

Features

- Worldwide FM band support (76–108 MHz)
- Advanced RDS/RBDS decoder
- DAB, DAB+ Band III support (168–240 MHz)
- Supports WorldDMB Receiver Profiles 1 and 2
- Integrated OFDM channel demodulator
- Integrated de-interleaving SRAM
- I²S digital audio out with ASRC
- Integrated 97 dB stereo audio DAC
- Concurrent I²S/L-R stereo audio out
- Full range of signal quality metrics
- Fully-integrated VCO / PLL / synthesizer
- SPI and I²C host control interfaces
- WLCSP 62-ball, 3.2x3.77x0.59 mm
- QFN 48-pin, 7x7x0.85 mm

Applications

- Mobile phones and tablets
- Clock and tabletop radios
- Stereo boomboxes
- Mini/micro systems
- Docking stations
- Personal navigation devices





Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Ambient Temperature	T _A		−40	25	85	°C
Analog Supply Voltage	V _A		1.71	1.8	2.0	V
Interface Supply Voltage	V _{IO}		1.62	1.8	3.6	V
Core Digital Supply Voltage	V _{CORE}		1.62	1.8	2.0	V
Memory Supply Voltage	V _{MEM}		1.62	1.8	2.0	V
Analog FM						
Input Frequency	F _{rf}		76	—	108	MHz
Seek Time			—	—	60	ms/ch
DAB/DAB+						
Input Frequency	F _{rf}		168	—	240	MHz
Enable Acquisition Time			—	—	940	ms

The technical drawing consists of three views of a mechanical component:

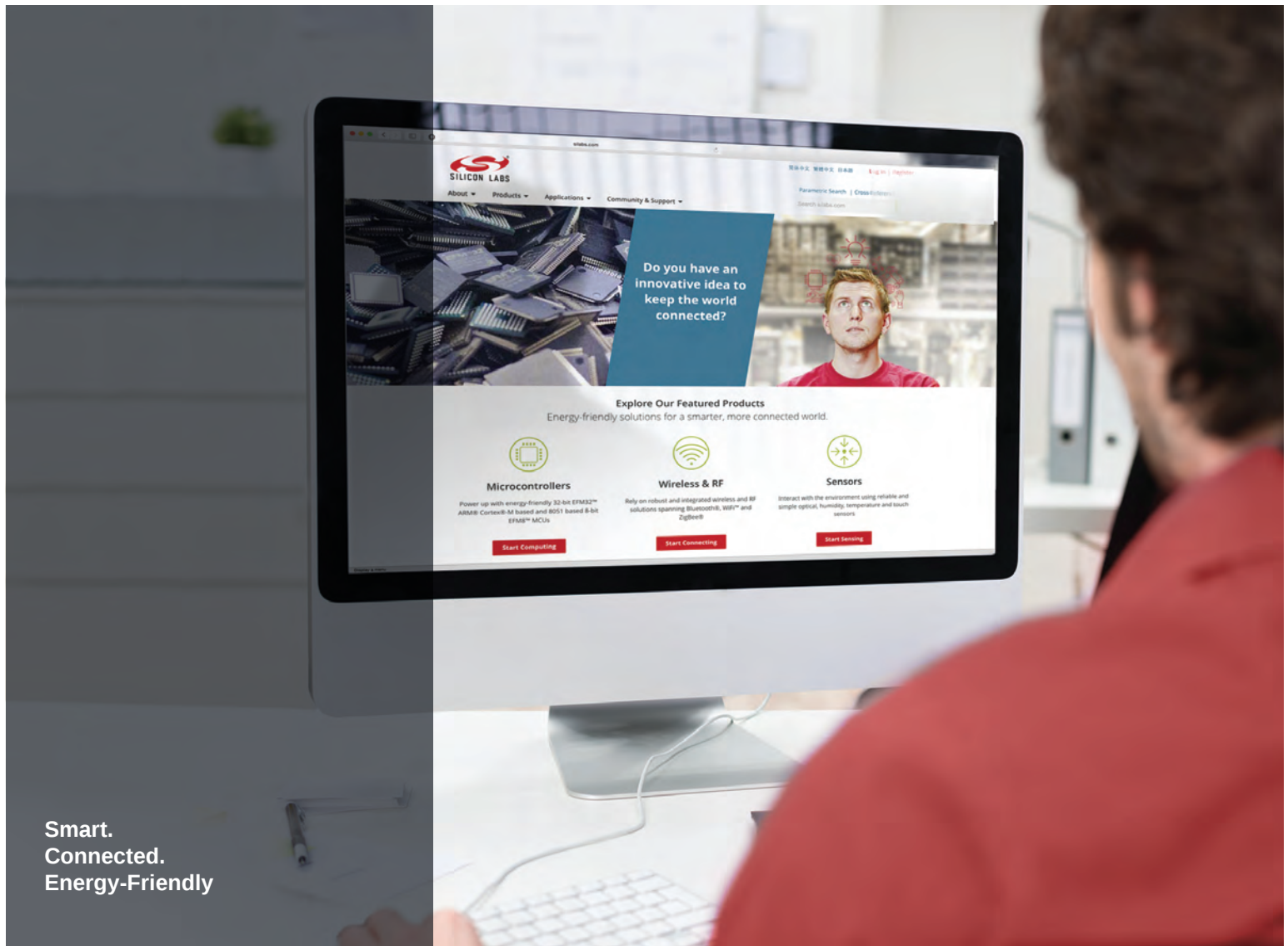
- Front View (Top Left):** A rectangular plate with overall width D and height E . The top edge has a fillet radius $R1.5$ labeled "CLASSIC RADIUS". The bottom edge has a fillet radius $R1$. The center of gravity is marked with a dot. Dimensions include $D/2$, $E/2$, and $2X$.
- Side View (Top Right):** A profile view showing the thickness of the plate as $2X$. The total width is $D2$, and the distance from the centerline to the outer edge is $D/2$. The total height is $E2$, with $E/2$ from the centerline. A detail callout "DETAIL 'A'" points to a specific feature.
- Detail View (Bottom):** A cross-sectional view of a pin or fastener. It shows a semi-circular head with a diameter of $\varnothing 0.2830$ and a length of L . The pin has a diameter of $\varnothing \text{PIN } \varnothing R0.20$ and a thread section with a diameter of 4.8 . The label "DETAIL - 'A'" is at the bottom.

Notes:

1. All dimensions are shown in millimeters (mm) unless otherwise noted.
2. Dimensioning and tolerancing per ASME Y14.5M-1994.
3. This drawing conforms to JEDEC Outline MO-220, Variation VKKD-4.
4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

Notes:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. Primary datum "C" and seating plane are defined by the spherical crowns of the solder balls.
4. Dimension "b" is measured at the maximum solder bump diameter, parallel to primary datum "C".
5. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

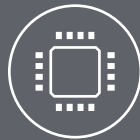


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